# **ER1A THRU ER1J**



## SURFACE MOUNT SUPERFAST RECOVERY RECTIFIER

**REVERSE VOLTAGE: 50 to 600 VOLTS** http://www.njzrg.com FORWARD CURRENT: 1.0 AMPERE

**FEATURES** 

### · For surface mounted applications

- · Low profile package
- · Built-in strain relief
- · Easy pick and place
- · Superfast recovery times for high efficiency
- · Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

· High temperature soldering : 260°C /10 seconds at terminals

#### **MECHANICAL DATA**

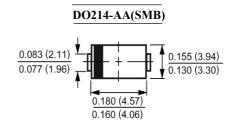
Case: Molded plastic, DO-214AA(SMB)

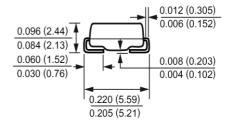
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481

Weight: 0.003 ounce, 0.093 gram





Dimensions in inches and (millimeters)

### Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	ER1A	ER1B	ER1C	ER1D	ER1E	ER1G	ER1J	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	150	200	300	400	600	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	105	140	210	280	420	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	300	400	600	Volts
Maximum Average Forward Rectified Current at $T_L$ =100	I <sub>(AV)</sub>				1.0				Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	$I_{FSM}$	I <sub>FSM</sub> 30						Amp	
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 1.0A	$V_{\rm F}$	0.95				1.	1.25 1.70		Volts
Maximum Reverse Current at T <sub>A</sub> =25	$I_R$	5.0							μAmp
at Rated DC Blocking Voltage T <sub>A</sub> =100	I <sub>R</sub>	100							
Typical Junction Capacitance (Note 1)	$C_{J}$	10							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	35							/W
Maximum Reverse Recovery Time (Note 3)	T <sub>RR</sub>	35 50						nS	
Operating Junction Temperature Range	$T_{J}$	-55 to +150							
Storage Temperature Range	Tstg	-55 to +150							

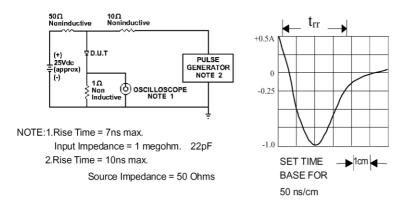
#### **NOTES:**

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions :  $I_F$ =.5A ,  $I_R$ =1A ,  $I_{RR}$ =.25A.



#### RATINGS AND CHARACTERISTIC CURVES

http://www.njzrg.com



2.0 SINGLE PHASE HALF WAVE RESISTIVE OR INDUCTIVE P.C.B MOUNTED ON 0.315×0.315\*(8.0×8.0mm) PAD AREAS

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2.5 50 75 100 125 150 175

LEAD TEMPERATURE,

Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

Fig. 2-MAXIMUM AVERAGE FORWARD CURRENT RATING

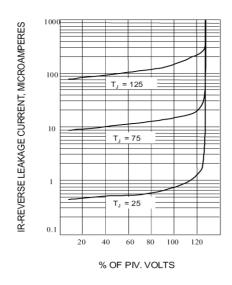
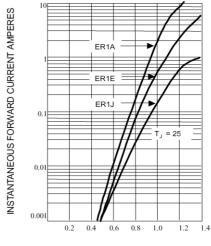


Fig. 3-TYPICAL REVERSE CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE VOLTS

Fig. 4-TYPICAL FORWARD CHARACTERISTICS

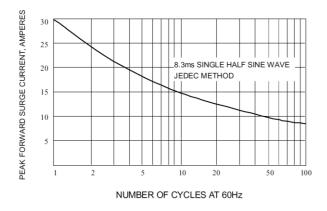


Fig. 5-MAXIMUM NON-REPETITIVE SURGE CURRENT

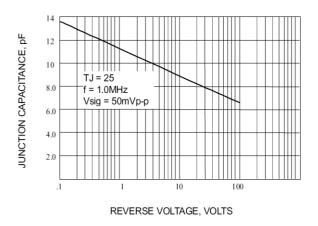


Fig. 6-TYPICAL JUNCTION CAPACITANCE